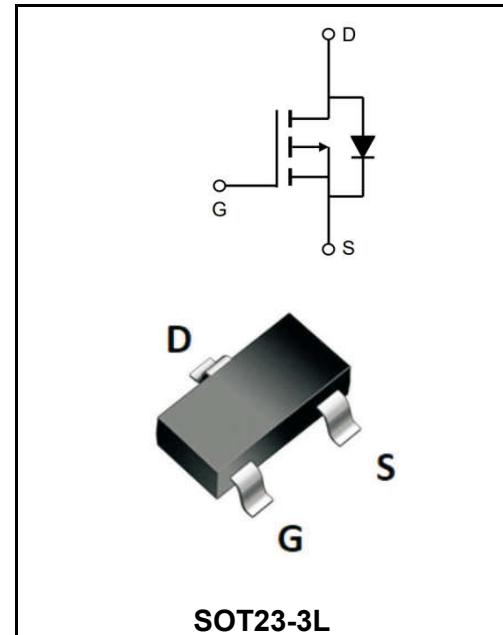


**-55V P-CHANNEL ENHANCEMENT MODE MOSFET**
**MAIN CHARACTERISTICS**

$I_D$	-4.2A
$V_{DSS}$	-55V
$R_{DS(on)-typ}(@V_{GS}=-10V)$	< 125m $\Omega$ (Type:108 m $\Omega$ )



Marking Code	
YFW4P05MI	4P05

**Maximum Ratings at  $T_c=25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbols	Value	Units
Drain-Source Voltage	$V_{DS}$	-55	V
Gate - Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current, $V_{GS} @ -10V^1$ @ $T_A=25^\circ\text{C}$	$I_D$	-4.2	A
Continuous Drain Current, $V_{GS} @ -10V^1$ @ $T_A=70^\circ\text{C}$	$I_D$	-2.4	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	-16	A
Total Power Dissipation <sup>3</sup> @ $T_A=25^\circ\text{C}$	$P_D$	1	W
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-55 to +150	$^\circ\text{C}$
Thermal Resistance Junction-Ambient <sup>1</sup>	$R_{\theta JA}$	125	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction to Case <sup>1</sup>	$R_{\theta JC}$	80	$^\circ\text{C}/\text{W}$

**Maximum Ratings at T<sub>c</sub>=25°C unless otherwise specified**

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	BV <sub>DSS</sub>	-55	-58	-	V
BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA	ΔBV <sub>DSS/ΔTJ</sub>	-	-0.021	-	V/°C
Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.5A	R <sub>DS(ON)</sub>	-	108	125	mΩ
	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1A		-	125	155	
Gate -Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	V <sub>GS(th)</sub>	-1.0	1.6	-2.5	V
V <sub>GS(th)</sub> Temperature Coefficient		ΔV <sub>GS(th)</sub>	-	4.08	-	mV/°C
Drain-Source Leakage Current	V <sub>DS</sub> =-48V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C	I <sub>DSS</sub>	-	-	1	μA
	V <sub>DS</sub> =-48V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C		-	-	5	
Gate –Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	I <sub>GSS</sub>	-	-	±100	nA
Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-1.5V	g <sub>fs</sub>	-	5.9	-	S
Total Gate Charge(-4.5V)	V <sub>DS</sub> =-20V V <sub>GS</sub> =-4.5V I <sub>D</sub> =-1.5A	Q <sub>g</sub>	-	4.6	-	nC
Gate-Source Charge		Q <sub>gs</sub>	-	1.4	-	
Gate-Drain Charge		Q <sub>gd</sub>	-	1.62	-	
Turn-on delay time	V <sub>DS</sub> =-15V V <sub>GS</sub> =-10V I <sub>D</sub> = -1A R <sub>G</sub> =3.3Ω	t <sub>d(on)</sub>	-	17.4	-	ns
Rise Time		T <sub>r</sub>	-	5.4	-	
Turn-Off Delay Time		t <sub>d(OFF)</sub>	-	37.2	-	
Fall Time		t <sub>f</sub>	-	2.4	-	
Input Capacitance	V <sub>DS</sub> =-15V V <sub>GS</sub> =0V f=1MHz	C <sub>iss</sub>	-	531	-	pF
Output Capacitance		C <sub>oss</sub>	-	59	-	
Reverse Transfer Capacitance		C <sub>rss</sub>	-	38	-	
Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	I <sub>s</sub>	-	-	-1.7	A
Pulsed Source Current <sup>2,4</sup>		I <sub>SM</sub>	-	-	-7	A
Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C	V <sub>SD</sub>	-	-	-1.2	V

Note :

1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
3. The power dissipation is limited by 150°C junction temperature
4. The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

### Ratings and Characteristic Curves

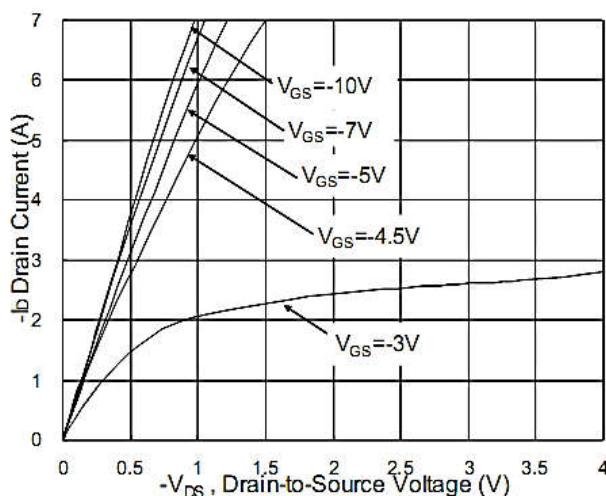


Fig.1 Typical Output Characteristics

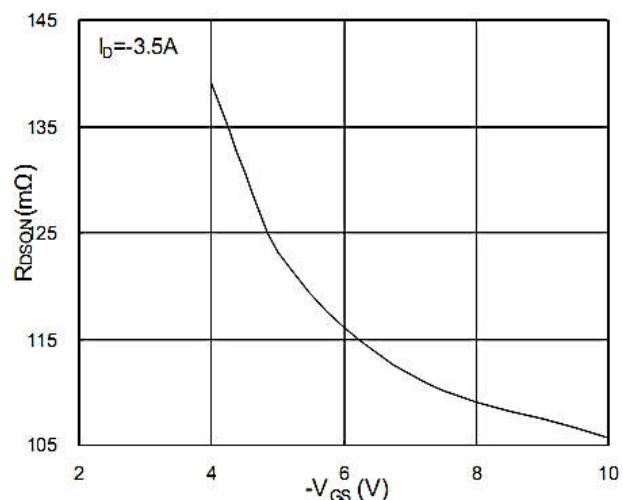


Fig.2 On-Resistance v.s Gate-Source

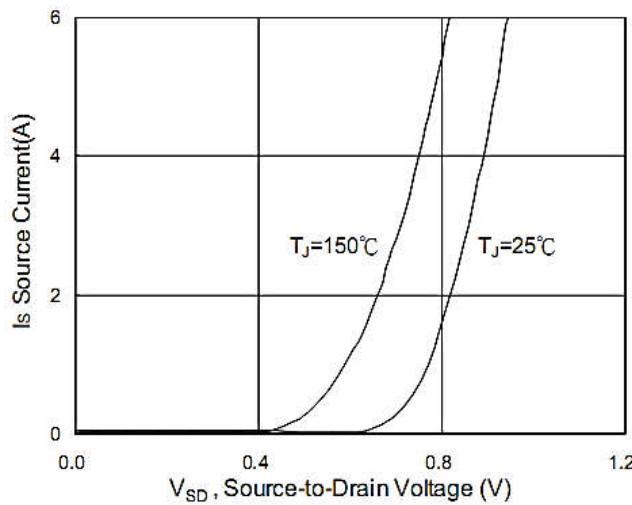


Fig.3 Forward Characteristics Of Reverse

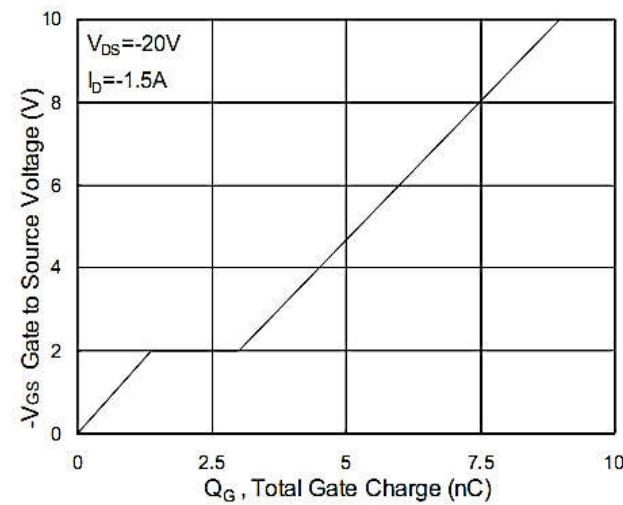


Fig.4 Gate-Charge Characteristics

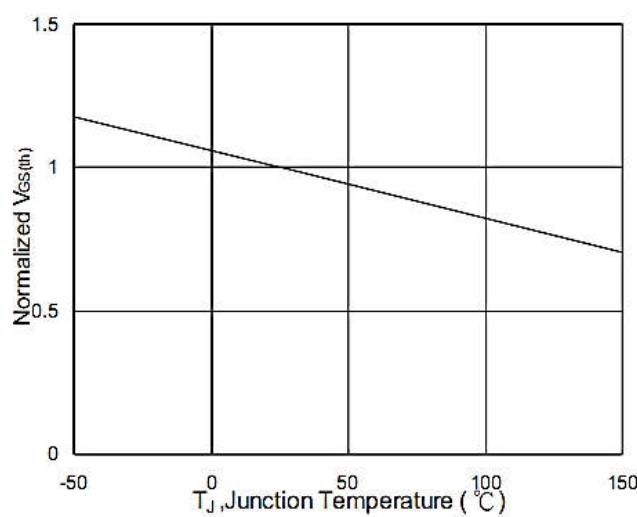


Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$

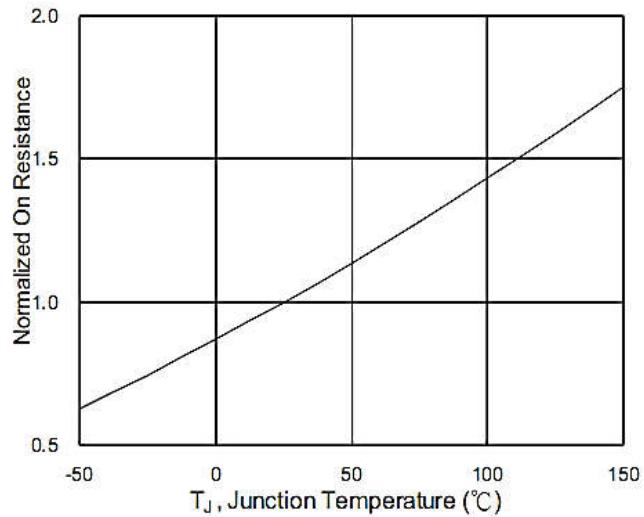


Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$

**Ratings and Characteristic Curves**

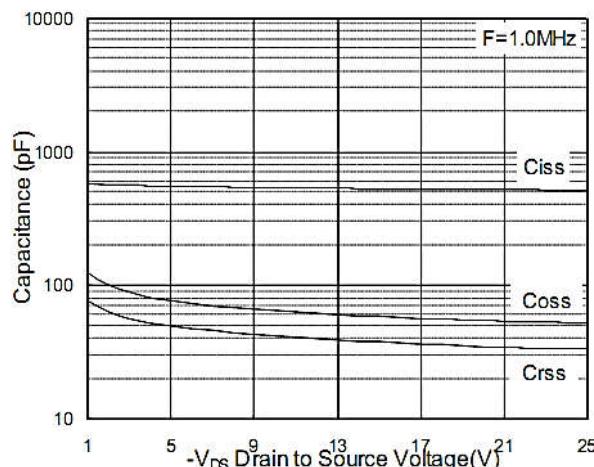


Fig.7 Capacitance

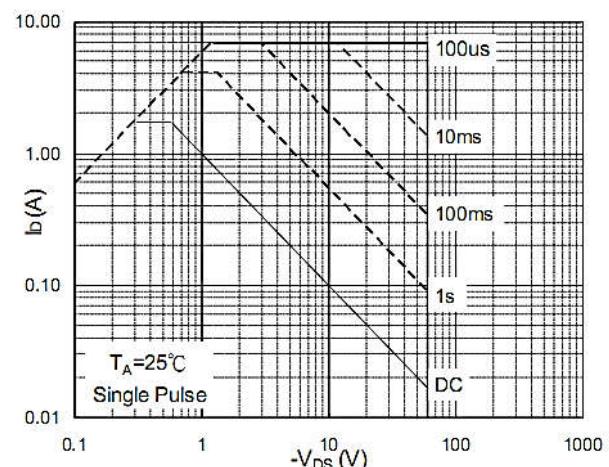


Fig.8 Safe Operating Area

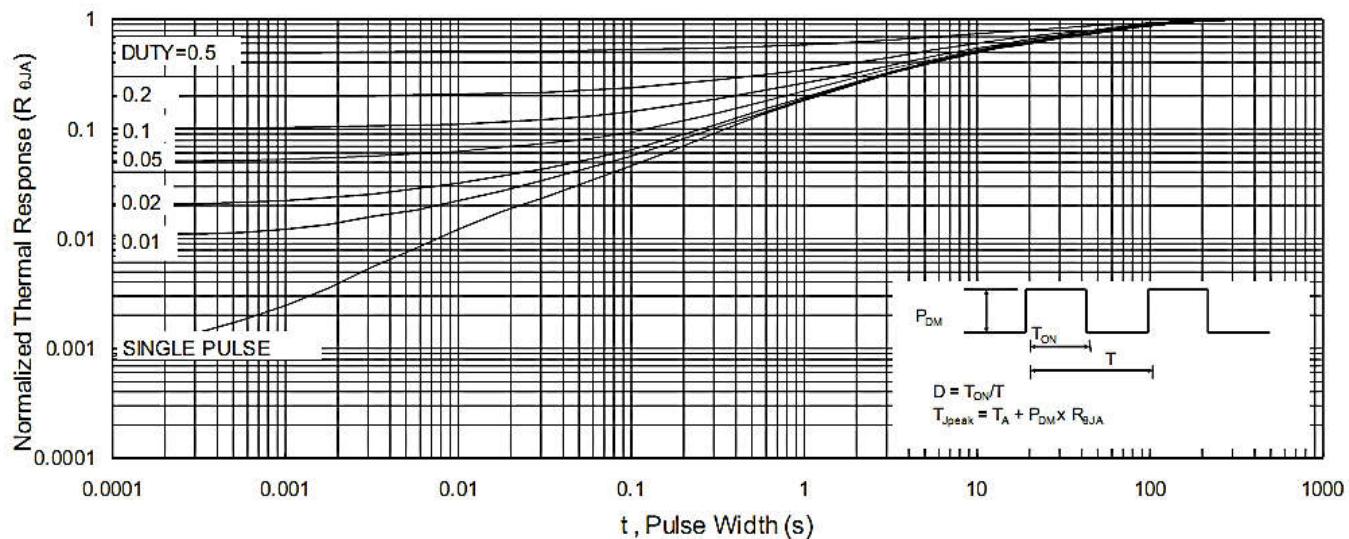


Fig.9 Normalized Maximum Transient Thermal Impedance

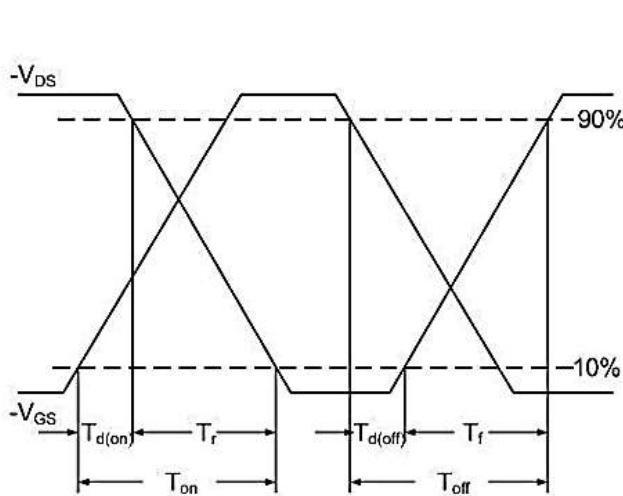


Fig.10 Switching time waveform

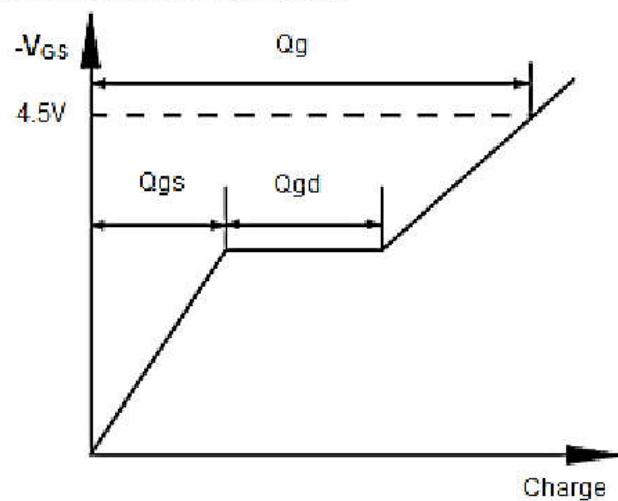


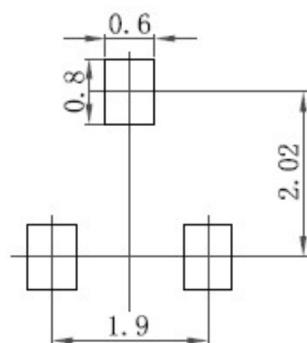
Fig.11 Gate Charge waveform

**Ordering information**

Package	Packing Description	Base Quantity	Packing Quantity
SOT23-3L	Tape/Reel,7"reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

**Package Dimensions**
**SOT23-3L**

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	1.05	1.25	41	49.2
A1		0.10		3.93
A2	1.05	1.15	41	45
b	0.30	0.50	12	20
c	0.10	0.20	3.93	7.9
D	2.82	3.02	111	119
E	1.50	1.70	59	67
E1	2.65	2.95	104	116
e		0.95		37.4
e1	1.80	2.00	71	78
L	0.30	0.066	12	26
Θ			8°	

**The recommended mounting pad size**


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